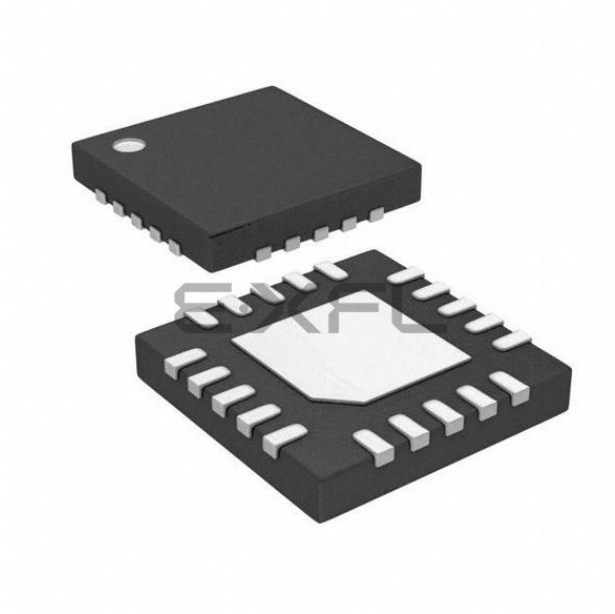

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	18
Program Memory Size	7KB (4K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 17x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	20-UFQFN Exposed Pad
Supplier Device Package	20-UQFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f15344t-i-gz

TABLE 1-2: PIC16(L)F15324 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
OUT(2)	C1OUT	—	CMOS/OD	Comparator 1 output.
	C2OUT	—	CMOS/OD	Comparator 2 output.
	SDO1	—	CMOS/OD	MSSP1 SPI serial data output.
	SCK1	—	CMOS/OD	MSSP1 SPI serial clock output.
	DT1(3)	—	CMOS/OD	EUSART Synchronous mode data output.
	TX1	—	CMOS/OD	EUSART1 Asynchronous mode transmitter data output.
	CK1	—	CMOS/OD	EUSART1 Synchronous mode clock output.
	DT2(3)	—	CMOS/OD	EUSART Synchronous mode data output.
	TX2	—	CMOS/OD	EUSART2 Asynchronous mode transmitter data output.
	CK2	—	CMOS/OD	EUSART2 Synchronous mode clock output.
	SCL1(3,4)	—	CMOS/OD	MSSP1 I^2C output.
	SDA1(3,4)	—	CMOS/OD	MSSP1 I^2C output.
	TMR0	—	CMOS/OD	Timer0 output.
	CCP1	—	CMOS/OD	CCP1 output (compare/PWM functions).
	CCP2	—	CMOS/OD	CCP2 output (compare/PWM functions).
	PWM3OUT	—	CMOS/OD	PWM3 output.
	PWM4OUT	—	CMOS/OD	PWM4 output.
	PWM5OUT	—	CMOS/OD	PWM5 output.
	PWM6OUT	—	CMOS/OD	PWM6 output.
	CWG1A	—	CMOS/OD	Complementary Waveform Generator 1 output A.
	CWG1B	—	CMOS/OD	Complementary Waveform Generator 1 output B.
	CWG1C	—	CMOS/OD	Complementary Waveform Generator 1 output C.
	CWG1D	—	CMOS/OD	Complementary Waveform Generator 1 output D.
	CLC1OUT	—	CMOS/OD	Configurable Logic Cell 1 output.
	CLC2OUT	—	CMOS/OD	Configurable Logic Cell 2 output.
	CLC3OUT	—	CMOS/OD	Configurable Logic Cell 3 output.
	CLC4OUT	—	CMOS/OD	Configurable Logic Cell 4 output.
	NCO1OUT	—	CMOS/OD	Numerically Controller Oscillator output.
	CLKR	—	CMOS/OD	Clock Reference module output.

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; OD = Open-Drain
TTL = TTL compatible input; ST = Schmitt Trigger input with CMOS levels; I^2C = Schmitt Trigger input with I^2C
HV = High Voltage; XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 15-3 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 15-3.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

TABLE 4-10: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 8-10											
CPU CORE REGISTERS; see Table 4-3 for specifics											
x0Ch/ x8Ch — x1Fh/ x9Fh	—	Unimplemented									

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

8.1 Power-on Reset (POR)

The POR circuit holds the device in Reset until VDD has reached an acceptable level for minimum operation. Slow rising VDD, fast operating speeds or analog performance may require greater than minimum VDD. The PWRT, BOR or MCLR features can be used to extend the start-up period until all device operation conditions have been met.

8.2 Brown-out Reset (BOR)

The BOR circuit holds the device in Reset when VDD reaches a selectable minimum level. Between the POR and BOR, complete voltage range coverage for execution protection can be implemented.

The Brown-out Reset module has four operating modes controlled by the BOREN<1:0> bits in Configuration Words. The four operating modes are:

- BOR is always on
- BOR is off when in Sleep
- BOR is controlled by software
- BOR is always off

Refer to Table 8-1 for more information.

The Brown-out Reset voltage level is selectable by configuring the BORV bit in Configuration Words.

A VDD noise rejection filter prevents the BOR from triggering on small events. If VDD falls below VBOR for a duration greater than parameter TBORDC, the device will reset. See Figure 8-2 for more information.

TABLE 8-1: BOR OPERATING MODES

BOREN<1:0>	SBOREN	Device Mode	BOR Mode	Instruction Execution upon: Release of POR or Wake-up from Sleep
11	x	X	Active	Wait for release of BOR(1) (BORRDY = 1)
10	x	Awake	Active	Waits for release of BOR (BORRDY = 1) Waits for BOR Reset release
		Sleep	Disabled	
01	1	X	Active	Waits for BOR Reset release (BORRDY = 1)
	0	X	Disabled	Begins immediately (BORRDY = x)
00	x	X	Disabled	

Note 1: In this specific case, “Release of POR” and “Wake-up from Sleep”, there is no delay in start-up. The BOR ready flag, (BORRDY = 1), will be set before the CPU is ready to execute instructions because the BOR circuit is forced on by the BOREN<1:0> bits.

8.2.1 BOR IS ALWAYS ON

When the BOREN bits of Configuration Words are programmed to ‘11’, the BOR is always on. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is active during Sleep. The BOR does not delay wake-up from Sleep.

8.2.2 BOR IS OFF IN SLEEP

When the BOREN bits of Configuration Words are programmed to ‘10’, the BOR is on, except in Sleep. The device start-up will be delayed until the BOR is ready and VDD is higher than the BOR threshold.

BOR protection is not active during Sleep. The device wake-up will be delayed until the BOR is ready.

REGISTER 10-17: PIR7: PERIPHERAL INTERRUPT REQUEST REGISTER 7

U-0	U-0	R/W/HS-0/0	R/W/HS-0/0	U-0	U-0	U-0	R/W/HS-0/0
—	—	NVMIF	NCO1IF	—	—	—	CWG1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7-6 **Unimplemented:** Read as '0'

bit 5 **NVMIF:** Nonvolatile Memory (NVM) Interrupt Flag bit
1 = The requested NVM operation has completed
0 = NVM interrupt not asserted

bit 4 **NCO1IF:** Numerically Controlled Oscillator (NCO) Interrupt Flag bit
1 = The NCO has rolled over
0 = No NCO interrupt event has occurred

bit 3-1 **Unimplemented:** Read as '0'

bit 0 **CWG1IF:** CWG1 Interrupt Flag bit
1 = CWG1 has gone into shutdown
0 = CWG1 is operating normally, or interrupt cleared

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

13.4 Register Definitions: Flash Program Memory Control

REGISTER 13-1: NVMDATL: NONVOLATILE MEMORY DATA LOW BYTE REGISTER

R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
NVMDAT<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **NVMDAT<7:0>**: Read/write value for Least Significant bits of program memory

REGISTER 13-2: NVMDATH: NONVOLATILE MEMORY DATA HIGH BYTE REGISTER

U-0	U-0	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u	R/W-x/u
—	—	NVMDAT<13:8>					
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-6 **Unimplemented:** Read as ‘0’

bit 5-0 **NVMDAT<13:8>**: Read/write value for Most Significant bits of program memory

REGISTER 13-3: NVMADRL: NONVOLATILE MEMORY ADDRESS LOW BYTE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
NVMADR<7:0>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7-0 **NVMADR<7:0>**: Specifies the Least Significant bits for program memory address

REGISTER 13-4: NVMADRH: NONVOLATILE MEMORY ADDRESS HIGH BYTE REGISTER

U-1	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
—(1)	NVMADR<14:8>						
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **Unimplemented:** Read as ‘1’

bit 6-0 **NVMADR<14:8>**: Specifies the Most Significant bits for program memory address

Note 1: Bit is undefined while WR = 1

REGISTER 16-1: PMD0: PMD CONTROL REGISTER 0

R/W-0/0	R/W-0/0	U-0	U-0	U-0	R/W-0/0	R/W-0/0	R/W-0/0
SYSCMD	FVRMD	—	—	—	NVMMD	CLKRMD	IOCMD
7							0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	q = Value depends on condition

bit 7 **SYSCMD:** Disable Peripheral System Clock Network bit
See description in **Section 16.4 "System Clock Disable"**.
1 = System clock network disabled (a.k.a. FOSC)
0 = System clock network enabled

bit 6 **FVRMD:** Disable Fixed Voltage Reference (FVR) bit
1 = FVR module disabled
0 = FVR module enabled

bit 5-3 **Unimplemented:** Read as '0'

bit 2 **NVMMD:** NVM Module Disable bit(1)
1 = User memory reading and writing is disabled; NVMCON registers cannot be written; FSR access to these locations returns zero.
0 = NVM module enabled

bit 1 **CLKRMD:** Disable Clock Reference CLKR bit
1 = CLKR module disabled
0 = CLKR module enabled

bit 0 **IOCMD:** Disable Interrupt-on-Change bit, All Ports
1 = IOC module(s) disabled
0 = IOC module(s) enabled

Note 1: When enabling NVM, a delay of up to 1 µs may be required before accessing data.

REGISTER 17-7: IOCCP: INTERRUPT-ON-CHANGE PORTC POSITIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCP7(1)	IOCCP6(1)	IOCCP5	IOCCP4	IOCCP3	IOCCP2	IOCCP1	IOCCP0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCCP<7:0>:** Interrupt-on-Change PORTC Positive Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a positive-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

Note 1: Present only in PIC16(L)F15344.

REGISTER 17-8: IOCCN: INTERRUPT-ON-CHANGE PORTC NEGATIVE EDGE REGISTER

R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0	R/W-0/0
IOCCN7(1)	IOCCN6(1)	IOCCN5	IOCCN4	IOCCN3	IOCCN2	IOCCN1	IOCCN0
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	

bit 7-0 **IOCCN<7:0>:** Interrupt-on-Change PORTC Negative Edge Enable bits
1 = Interrupt-on-Change enabled on the pin for a negative-going edge. IOCCFx bit and IOCIF flag will be set upon detecting an edge.
0 = Interrupt-on-Change disabled for the associated pin

Note 1: Present only in PIC16(L)F15344.

20.1 ADC Configuration

When configuring and using the ADC the following functions must be considered:

- Port configuration
- Channel selection
- ADC voltage reference selection
- ADC conversion clock source
- Interrupt control
- Result formatting

20.1.1 PORT CONFIGURATION

The ADC can be used to convert both analog and digital signals. When converting analog signals, the I/O pin will be configured for analog by setting the associated TRIS and ANSEL bits. Refer to **Section 14.0 "I/O Ports"** for more information.

Note:	Analog voltages on any pin that is defined as a digital input may cause the input buffer to conduct excess current.

20.1.2 CHANNEL SELECTION

There are several channel selections available:

- Six Port A channels
- Up to four Port B channels
- Up to eight Port C channels
- Temperature Indicator
- DAC output
- Fixed Voltage Reference (FVR)
- AVSS (Ground)

The CHS<5:0> bits of the ADCON0 register (Register 20-1) determine which channel is connected to the sample and hold circuit.

When changing channels, a delay is required before starting the next conversion. Refer to **Section 20.2 "ADC Operation"** for more information.

Note:	It is recommended that when switching from an ADC channel of a higher voltage to a channel of a lower voltage, that the user selects the VSS channel before connecting to the channel with the lower voltage. If the ADC does not have a dedicated VSS input channel, the VSS selection (DAC1R<4:0> = b'00000') through the DAC output channel can be used. If the DAC is in use, a free input channel can be connected to VSS, and can be used in place of the DAC.

20.1.3 ADC VOLTAGE REFERENCE

The ADPREF<1:0> bits of the ADCON1 register provides control of the positive voltage reference. The positive voltage reference can be:

- VREF+ pin
- VDD
- FVR 2.048V
- FVR 4.096V (Not available on LF devices)

The ADPREF bit of the ADCON1 register provides control of the negative voltage reference. The negative voltage reference can be:

- VREF- pin
- VSS

See **Section 18.0 "Fixed Voltage Reference (FVR)"** for more details on the Fixed Voltage Reference.

20.1.4 CONVERSION CLOCK

The source of the conversion clock is software selectable via the ADCS<2:0> bits of the ADCON1 register. There are seven possible clock options:

- FOSC/2
- FOSC/4
- FOSC/8
- FOSC/16
- FOSC/32
- FOSC/64
- ADCRC (dedicated RC oscillator)

The time to complete one bit conversion is defined as TAD. One full 10-bit conversion requires 11.5 TAD periods as shown in Figure 20-2.

For correct conversion, the appropriate TAD specification must be met. Refer to Table 37-13 for more information. Table 20-1 gives examples of appropriate ADC clock selections.

Note:	Unless using the ADCRC, any changes in the system clock frequency will change the ADC clock frequency, which may adversely affect the ADC result.

TABLE 20-1: ADC CLOCK PERIOD (TAD) VS. DEVICE OPERATING FREQUENCIES

ADC Clock Period (TAD)		Device Frequency (FOSC)					
ADC Clock Source	ADCS<2:0>	32 MHz	20 MHz	16 MHz	8 MHz	4 MHz	1 MHz
FOSC/2	000	62.5ns(2)	100 ns(2)	125 ns(2)	250 ns(2)	500 ns(2)	2.0 μs
FOSC/4	100	125 ns(2)	200 ns(2)	250 ns(2)	500 ns(2)	1.0 μs	4.0 μs
FOSC/8	001	0.5 μs(2)	400 ns(2)	0.5 μs(2)	1.0 μs	2.0 μs	8.0 μs(3)
FOSC/16	101	800 ns	800 ns	1.0 μs	2.0 μs	4.0 μs	16.0 μs(3)
FOSC/32	010	1.0 μs	1.6 μs	2.0 μs	4.0 μs	8.0 μs(3)	32.0 μs(2)
FOSC/64	110	2.0 μs	3.2 μs	4.0 μs	8.0 μs(3)	16.0 μs(2)	64.0 μs(2)
ADCRC	x11	1.0-6.0 μs(1,4)	1.0-6.0 μs(1,4)	1.0-6.0 μs(1,4)	1.0-6.0 μs(1,4)	1.0-6.0 μs(1,4)	1.0-6.0 μs(1,4)

Legend: Shaded cells are outside of recommended range.

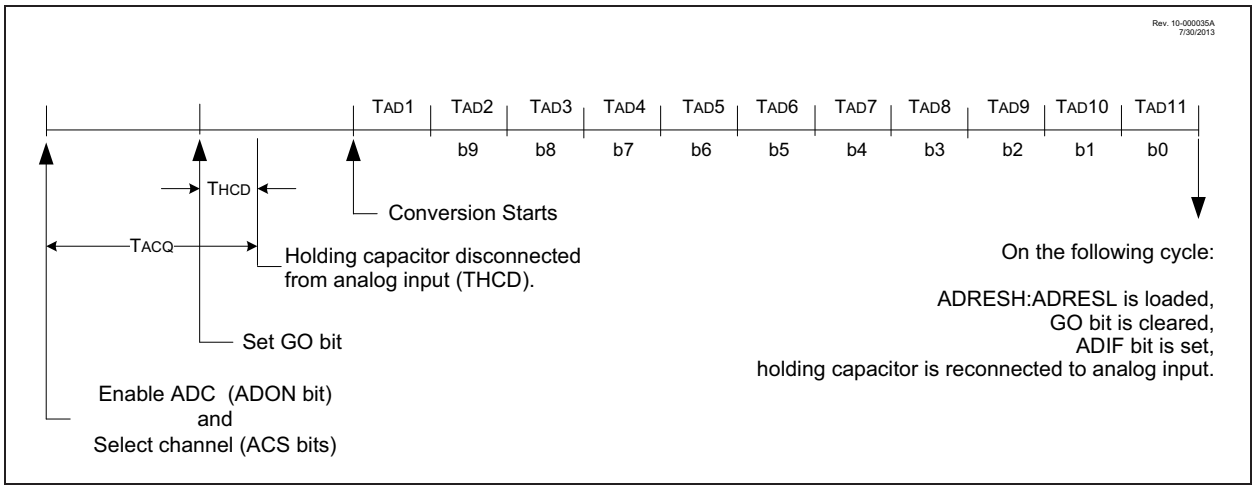
Note 1: See TAD parameter for ADCRC source typical TAD value.

2: These values violate the required TAD time.

3: Outside the recommended TAD time.

4: The ADC clock period (TAD) and total ADC conversion time can be minimized when the ADC clock is derived from the system clock FOSC. However, the ADCRC oscillator source must be used when conversions are to be performed with the device in Sleep mode.

FIGURE 20-2: ANALOG-TO-DIGITAL CONVERSION TAD CYCLES



23.0 COMPARATOR MODULE

Comparators are used to interface analog circuits to a digital circuit by comparing two analog voltages and providing a digital indication of their relative magnitudes. Comparators are very useful mixed signal building blocks because they provide analog functionality independent of program execution. The analog comparator module includes the following features:

- Programmable input selection
- Selectable voltage reference
- Programmable output polarity
- Rising/falling output edge interrupts
- CWG1 Auto-shutdown source

23.1 Comparator Overview

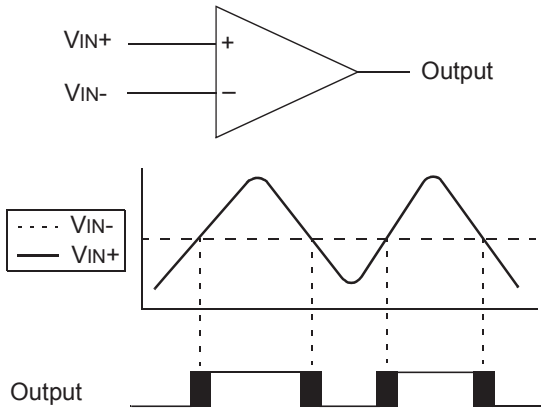
A single comparator is shown in Figure 23-1 along with the relationship between the analog input levels and the digital output. When the analog voltage at VIN+ is less than the analog voltage at VIN-, the output of the comparator is a digital low level. When the analog voltage at VIN+ is greater than the analog voltage at VIN-, the output of the comparator is a digital high level.

The comparators available are shown in Table 23-1.

TABLE 23-1: AVAILABLE COMPARATORS

Device	C1	C2
PIC16(L)F15324/44	•	•

FIGURE 23-1: SINGLE COMPARATOR



Note: The black areas of the output of the comparator represents the uncertainty due to input offsets and response time.

24.2 ZCD Logic Output

The ZCD module includes a Status bit, which can be read to determine whether the current source or sink is active. The OUT bit of the ZCDxCON register is set when the current sink is active, and cleared when the current source is active. The OUT bit is affected by the polarity even if the module is disabled.

24.3 ZCD Logic Polarity

The POL bit of the ZCDxCON register inverts the ZCDxOUT bit relative to the current source and sink output. When the POL bit is set, a OUT high indicates that the current source is active, and a low output indicates that the current sink is active.

The POL bit affects the ZCD interrupts. See **Section 24.4 "ZCD Interrupts"**.

24.4 ZCD Interrupts

An interrupt will be generated upon a change in the ZCD logic output when the appropriate interrupt enables are set. A rising edge detector and a falling edge detector are present in the ZCD for this purpose.

The ZCDIF bit of the PIR2 register will be set when either edge detector is triggered and its associated enable bit is set. The INTP enables rising edge interrupts and the INTN bit enables falling edge interrupts. Both are located in the ZCDxCON register.

To fully enable the interrupt, the following bits must be set:

- ZCDIE bit of the PIE2 register
- INTP bit of the ZCDxCON register (for a rising edge detection)
- INTN bit of the ZCDxCON register (for a falling edge detection)
- PEIE and GIE bits of the INTCON register

Changing the POL bit can cause an interrupt, regardless of the level of the EN bit.

The ZCDIF bit of the PIR2 register must be cleared in software as part of the interrupt service. If another edge is detected while this flag is being cleared, the flag will still be set at the end of the sequence.

24.5 Correcting for V_{CPINV} offset

The actual voltage at which the ZCD switches is the reference voltage at the noninverting input of the ZCD op amp. For external voltage source waveforms other than square waves, this voltage offset from zero causes the zero-cross event to occur either too early or too late.

24.5.1 CORRECTION BY AC COUPLING

When the external voltage source is sinusoidal then the effects of the V_{CPINV} offset can be eliminated by isolating the external voltage source from the ZCD pin with a capacitor in addition to the voltage reducing resistor. The capacitor will cause a phase shift resulting in the ZCD output switch in advance of the actual zero crossing event. The phase shift will be the same for both rising and falling zero crossings, which can be compensated for by either delaying the CPU response to the ZCD switch by a timer or other means, or selecting a capacitor value large enough that the phase shift is negligible.

To determine the series resistor and capacitor values for this configuration, start by computing the impedance, Z, to obtain a peak current of 300 uA. Next, arbitrarily select a suitably large non-polar capacitor and compute its reactance, Xc, at the external voltage source frequency. Finally, compute the series resistor, capacitor peak voltage, and phase shift by the formulas shown in Equation 24-2.

EQUATION 24-2: R-C CALCULATIONS

V_{PEAK} = external voltage source peak voltage

f = external voltage source frequency

C = series capacitor

R = series resistor

V_C = Peak capacitor voltage

Φ = Capacitor induced zero crossing phase advance in radians

T_Φ = Time ZC event occurs before actual zero crossing

$Z = V_{PEAK}/3x10^{-4}$

$Xc = 1/(2\prod fC)$

$R = \sqrt{(Z^2 - Xc^2)}$

$V_C = Xc(3x10^{-4})$

$\Phi = Tan^{-1}(Xc/R)$

$T_\Phi = \Phi/(2\prod f)$

26.1 Timer1 Operation

The Timer1 modules are 16-bit incrementing counters which are accessed through the TMR1H:TMR1L register pairs. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

The timer is enabled by configuring the TMR1ON and GE bits in the T1CON and T1GCON registers, respectively. Table 26-1 displays the Timer1 enable selections.

TABLE 26-1: TIMER1 ENABLE SELECTIONS

TMR1ON	TMR1GE	Timer1 Operation
1	1	Count Enabled
1	0	Always On
0	1	Off
0	0	Off

26.2 Clock Source Selection

The T1CLK register is used to select the clock source for the timer. Register 26-3 shows the possible clock sources that may be selected to make the timer increment.

26.2.1 INTERNAL CLOCK SOURCE

When the internal clock source FOSC is selected, the TMR1H:TMR1L register pair will increment on multiples of FOSC as determined by the respective Timer1 prescaler.

When the FOSC internal clock source is selected, the timer register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the TMR1H:TMR1L value. To utilize the full resolution of the timer in this mode, an asynchronous input signal must be used to gate the timer clock input.

Out of the total timer gate signal sources, the following subset of sources can be asynchronous and may be useful for this purpose:

- CLC4 output
- CLC3 output
- CLC2 output
- CLC1 output
- Zero-Cross Detect output
- Comparator2 output
- Comparator1 output
- TxG PPS remappable input pin

26.2.2 EXTERNAL CLOCK SOURCE

When the timer is enabled and the external clock input source (ex: T1CKI PPS remappable input) is selected as the clock source, the timer will increment on the rising edge of the external clock input.

When using an external clock source, the timer can be configured to run synchronously or asynchronously, as described in **Section 26.4 "Timer Operation in Asynchronous Counter Mode"**.

Note: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:

- The timer is first enabled after POR
- Firmware writes to TMR1H or TMR1L
- The timer is disabled
- The timer is re-enabled (e.g., TMR1ON-->1) when the T1CKI signal is currently logic low.

FIGURE 26-4: TIMER1 GATE TOGGLE MODE

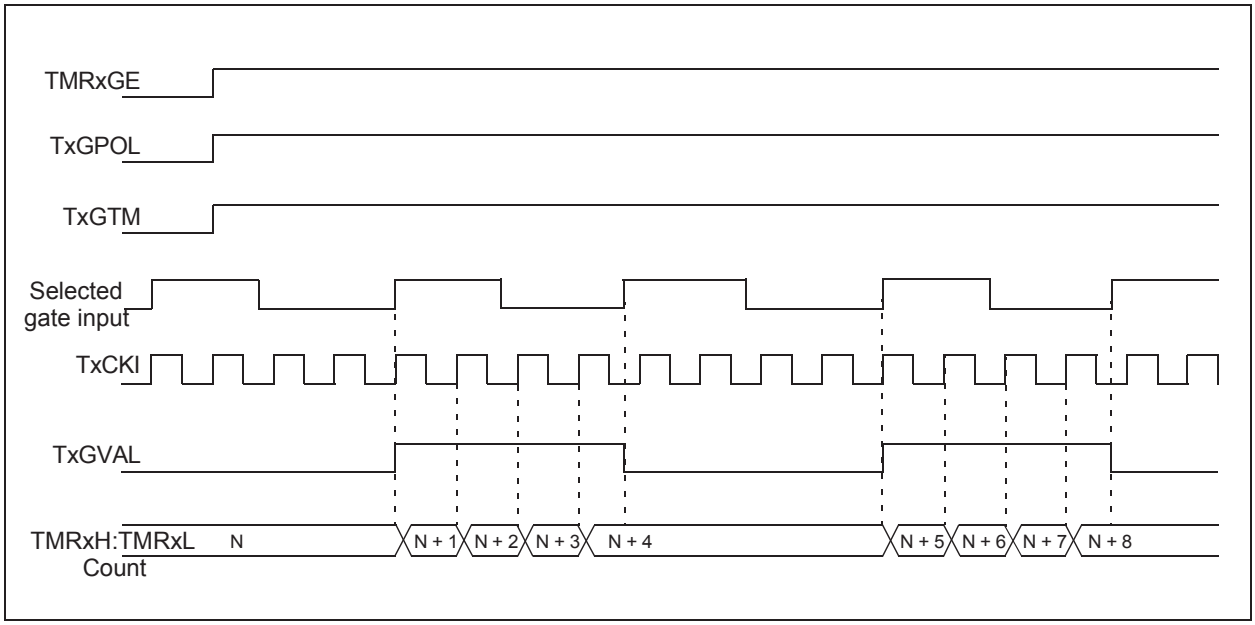
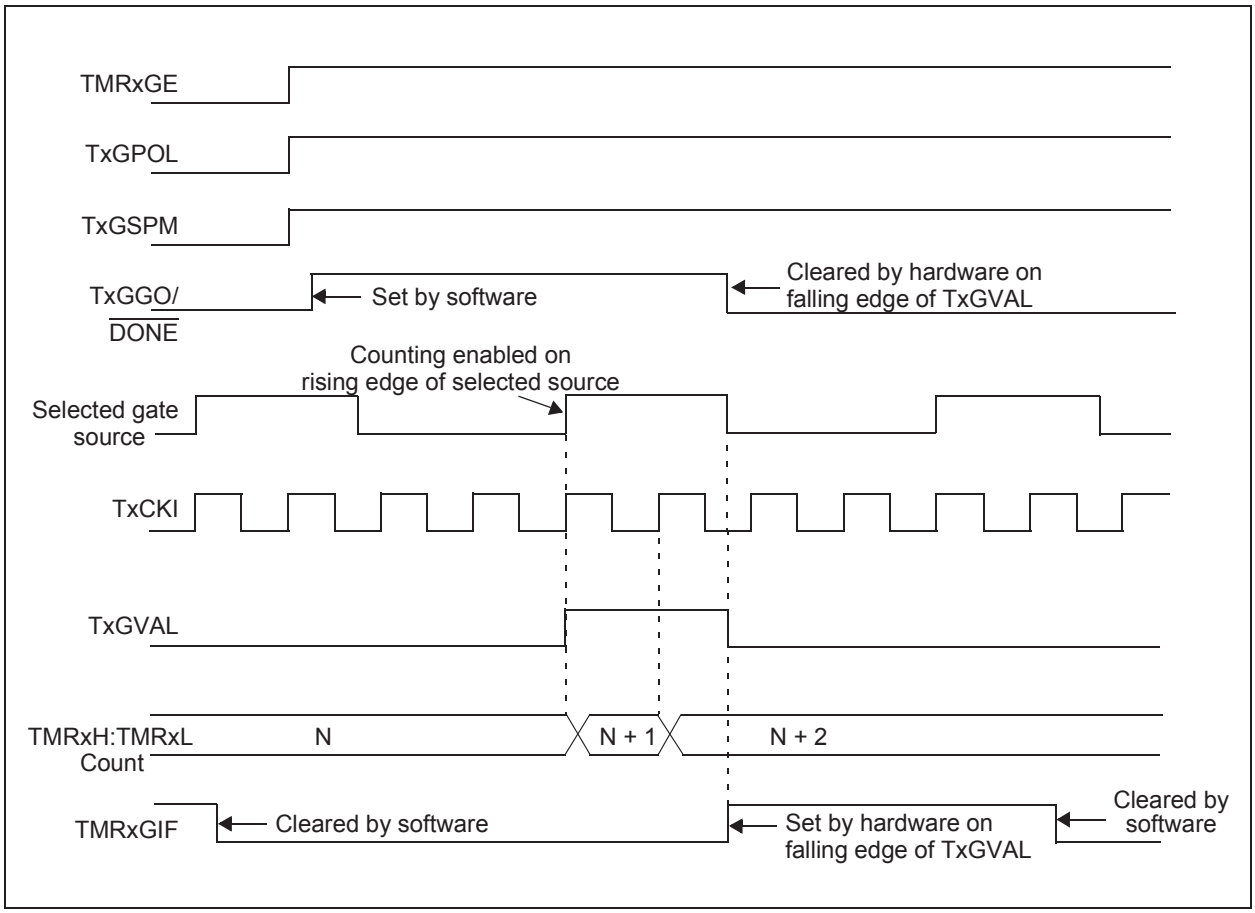


FIGURE 26-5: TIMER1 GATE SINGLE-PULSE MODE



REGISTER 26-4: T1GATE TIMER1 GATE SELECT REGISTER

U-0	U-0	U-0	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u	R/W-0/u
—	—	—	GSS<4:0>				
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HC = Bit is cleared by hardware

bit 7-5 **Unimplemented:** Read as ‘0’

bit 4-0 **GSS<4:0>:** Timer1 Gate Select bits

11111-10001 = Reserved
10000 = LC4_out
01111 = LC3_out
01110 = LC2_out
01101 = LC1_out
00100 = ZCD1_output
01011 = C2OUT_sync
01010 = C1OUT_sync
01001 = NCO1_out
01000 = PWM6_out
00111 = PWM5_out
00110 = PWM4_out
00101 = PWM3_out
00100 = CCP2_out
00011 = CCP1_out
00010 = TMR2_postscaled
00001 = Timer0 overflow output
00000 = T1GPPS

27.6 Timer2 Operation During Sleep

When PSYNC = 1, Timer2 cannot be operated while the processor is in Sleep mode. The contents of the TMR2 and T2PR registers will remain unchanged while processor is in Sleep mode.

When PSYNC = 0, Timer2 will operate in Sleep as long as the clock source selected is also still running. Selecting the LFINTOSC, MFINTOSC, or HFINTOSC oscillator as the timer clock source will keep the selected oscillator running during Sleep.

REGISTER 28-1: CCPxCON: CCPx CONTROL REGISTER (CONTINUED)

bit 3-0 **MODE<3:0>:** CCPx Mode Select bits(1)

1111 - 1100 = PWM mode (Timer2 as the timer source)
1110 = Reserved
1101 = Reserved
1100 = Reserved

1011 = Compare mode: output will pulse 0-1-0; Clears TMR1
1010 = Compare mode: output will pulse 0-1-0
1001 = Compare mode: clear output on compare match
1000 = Compare mode: set output on compare match

0111 = Capture mode: every 16th rising edge of CCPx input
0110 = Capture mode: every 4th rising edge of CCPx input
0101 = Capture mode: every rising edge of CCPx input
0100 = Capture mode: every falling edge of CCPx input

0011 = Capture mode: every edge of CCPx input
0010 = Compare mode: toggle output on match
0001 = Compare mode: toggle output on match; clear TMR1
0000 = Capture/Compare/PWM off (resets CCPx module)

Note 1: All modes will set the CCPxIF bit, and will trigger an ADC conversion if CCPx is selected as the ADC trigger source.

30.3 Selectable Input Sources

The CWG generates the output waveforms from the input sources in Table 30-2.

TABLE 30-2: SELECTABLE INPUT SOURCES

Source Peripheral	Signal Name
CWG input PPS pin	CWG1IN PPS
CCP1	CCP1_out
CCP2	CCP2_out
PWM3	PWM3_out
PWM4	PWM4_out
PWM5	PWM5_out
PWM6	PWM6_out
NCO	NCO1_out
Comparator C1	C1OUT_sync
Comparator C2	C2OUT_sync
CLC1	LC1_out
CLC2	LC2_out
CLC3	LC3_out
CLC4	LC4_out

The input sources are selected using the CWG1ISM register.

30.4 Output Control

30.4.1 POLARITY CONTROL

The polarity of each CWG output can be selected independently. When the output polarity bit is set, the corresponding output is active-high. Clearing the output polarity bit configures the corresponding output as active-low. However, polarity does not affect the override levels. Output polarity is selected with the POLx bits of the CWG1CON1. Auto-shutdown and steering options are unaffected by polarity.

32.6.13.3 Bus Collision During a Stop Condition

Bus collision occurs during a Stop condition if:

a) After the SDA pin has been deasserted and allowed to float high, SDA is sampled low after the BRG has timed out (Case 1).

b) After the SCL pin is deasserted, SCL is sampled low before SDA goes high (Case 2).

The Stop condition begins with SDA asserted low. When SDA is sampled low, the SCL pin is allowed to float. When the pin is sampled high (clock arbitration), the Baud Rate Generator is loaded with SSP1ADD and counts down to zero. After the BRG times out, SDA is sampled. If SDA is sampled low, a bus collision has occurred. This is due to another master attempting to drive a data '0' (Figure 32-38). If the SCL pin is sampled low before SDA is allowed to float high, a bus collision occurs. This is another case of another master attempting to drive a data '0' (Figure 32-39).

FIGURE 32-38: BUS COLLISION DURING A STOP CONDITION (CASE 1)

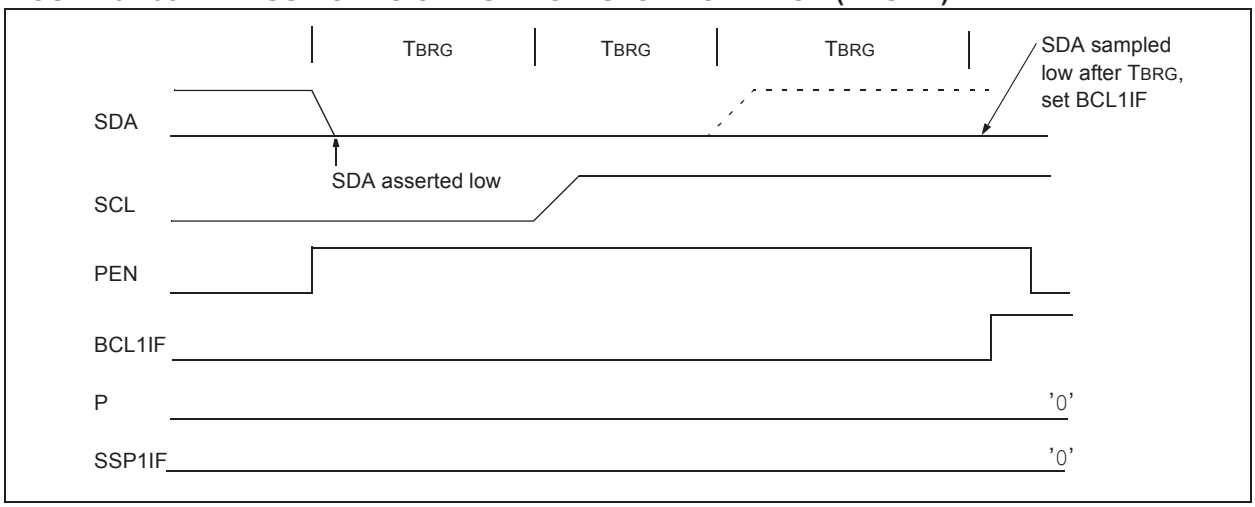
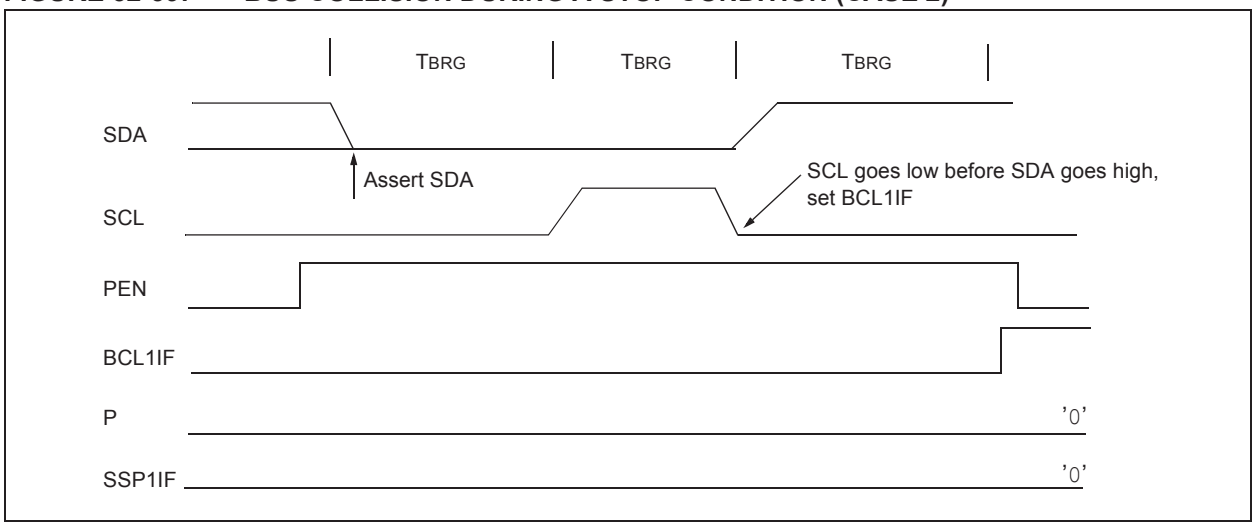


FIGURE 32-39: BUS COLLISION DURING A STOP CONDITION (CASE 2)



LSLF **Logical Left Shift**

Syntax: [*label*] LSLF f {,d}

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f<7>) → C
(f<6:0>) → dest<7:1>
0 → dest<0>

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the left through the Carry flag. A '0' is shifted into the LSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.

LSRF **Logical Right Shift**

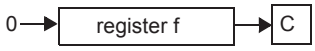
Syntax: [*label*] LSRF f {,d}

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: 0 → dest<7>
(f<7:1>) → dest<6:0>,
(f<0>) → C,

Status Affected: C, Z

Description: The contents of register 'f' are shifted one bit to the right through the Carry flag. A '0' is shifted into the MSb. If 'd' is '0', the result is placed in W. If 'd' is '1', the result is stored back in register 'f'.



MOVF **Move f**

Syntax: [*label*] MOVF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) → (dest)

Status Affected: Z

Description: The contents of register f is moved to a destination dependent upon the status of d. If d = 0, destination is W register. If d = 1, the destination is file register f itself. d = 1 is useful to test a file register since status flag Z is affected.

Words: 1

Cycles: 1

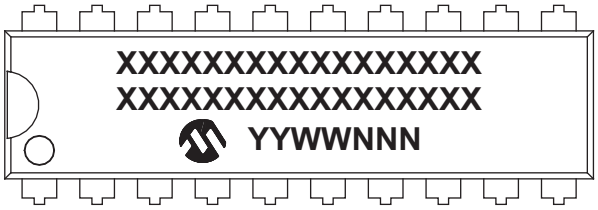
Example:

```
MOVF    FSR, 0
```

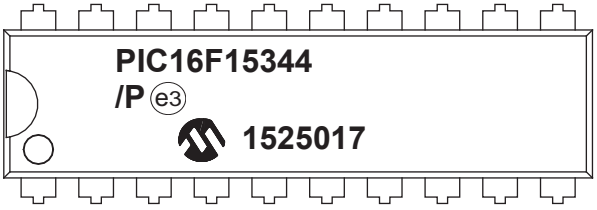
After Instruction
W = value in FSR register
Z = 1

40.1 Package Marking Information (Continued)

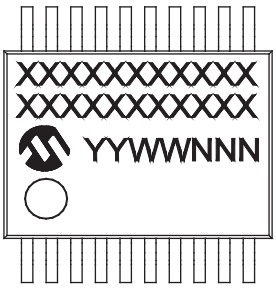
20-Lead PDIP (300 mil)



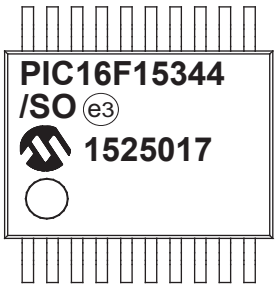
Example



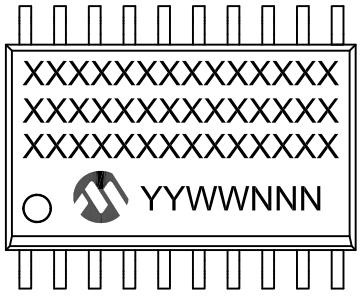
20-Lead SSOP (5.30 mm)



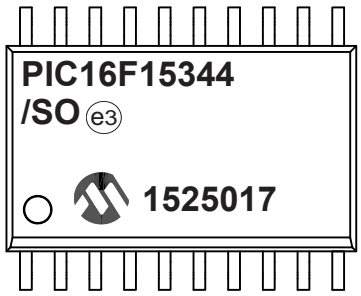
Example



20-Lead SOIC (7.50 mm)



Example



Legend:	XX...X	Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
		Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator ((e3)) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for customer-specific information.